1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

PECL Power Supply Voltage (V _{CC}) (Note 1)	+8V
NECL Power Supply Voltage (V _{EE}) (Note 2)	
PECL Mode Input Voltage (V _{IN}) (Note 3)	
NECL Mode Input Voltage (VIN) (Note 4)	
Continuous Output Current (I _{OUT})	
Surge Output Current (I _{OUT})	
ESD Rating (Note 5)	>2 kV

† Notice: Stresses above those listed under "Absolute Maximum ratings" may cause permanent damage to the device. Exposure to maximum rating conditions for extended periods may affect device reliability.

Note 1: $V_{EE} = 0V$.

2: V_{CC} = 0V.

- **3:** $V_{EE} = 0V, V_{IN} \le V_{CC}$.
- 4: $V_{CC} = 0V, V_{IN} \ge V_{EE}$.
- 5: Mil Std. 883 Human Body Model, all pins

DC ELECTRICAL CHARACTERISTICS (Note 1)

Electrical Characteristics: V_{CC} = 3.0V to 5.5V; V_{EE} = 0V or V_{EE} = -5.5V to -3.0V; V_{CC} = 0V; T_A = -40°C to +85°C, unless otherwise stated.

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions
Power Supply Current	I _{EE}		18	22	mA	T _A = -40°C to +25°C
Power Supply Current			21	26		T _A = +85°C
Output High Voltage (Note 2,	M	V _{CC} – 1.085		V _{CC} – 0.88	V	$T_A = -40^{\circ}C$
Note 3)	V _{OH}	V _{CC} – 1.025	V _{CC} – 0.955	V _{CC} – 0.88	V	$T_A = 0^{\circ}C$ to $85^{\circ}C$
Output Low Voltage (Note 2,		V _{CC} - 1.890		V _{CC} – 1.620		T _A = -40°C
Note 4) V _{CTRL} = V _{BB}	V _{OL}	V _{CC} – 1.870	VCC – 1.775	V _{CC} – 1.680		T _A = 0°C to 85°C
Output Low Voltage (Note 2)	V	V _{CC} – 1.180	—	V _{CC} – 0.975	v	$T_A = -40^{\circ}C$
$V_{CTRL} = V_{CC}$	V _{OL}	V _{CC} – 1.135	V _{CC} - 1.065	V _{CC} – 0.990	V	$T_A = 0^{\circ}C$ to $85^{\circ}C$
Input High Voltage (Single Ended)	V _{IH}	V _{CC} – 1.165	_	V _{CC} – 0.880	V	_
Input Low Voltage (Single Ended)	V _{IL}	V _{CC} – 1.810	_	V _{CC} – 1.475	V	_
Output Reference Voltage	V _{BB}	V _{CC} – 1.38	—	V _{CC} – 1.26	V	—
Common Modo Bango (Noto 5)	VIHCMR	V _{EE} + 2.0	—	V _{CC} - 0.4 V		T _A = -40°C
Common Mode Range (Note 5)		V _{EE} + 1.9	_	V _{CC} – 0.4		$T_A = 0^{\circ}C$ to $85^{\circ}C$
Input High Current	I			150	μA	D, /D
Input High Current	IIH			40		VCTRL

Note 1: Devices are designed to meet the DC specifications shown in the above table after thermal equilibration has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500 lfpm is maintained.

- 2: Outputs are terminated through a 50Ω resistor to V_{CC} 2.0V.
- **3:** $V_{CC} \ge V_{CTRL} \ge V_{EE.}$
- 4: If VCTRL is an open circuit, use the V_{OH} (max. & min.) and V_{OL} ($V_{CTRL} = V_{BB}$: max only) limits.

5: The CMR range is referenced to the most positive side of the differential input voltage. Normal operation is obtained if the high level falls within the specified range and the peak-to-peak voltage lies between 150 mV and 1V.

AC ELECTRICAL CHARACTERISTICS

Electrical Characteristics: V_{CC} = 3.0V to 5.5V; V_{EE} = 0V or V_{EE} = -5.5V to -3.0V; T_A = -40°C to +85°C, unless otherwise stated. R_L = 50 Ω to V_{CC} - 2.0V

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions
Propagation Delay D to Q (Differential)	+ +	175		325	ps	$T_A = -40^{\circ}C$ to $+25^{\circ}C$
	t _{PLH} , t _{PHL}	205	_	355		T _A = +85°C
		125	250	425	ps	T _A = -40°C
Propagation Delay D to Q (Single Ended)	t _{PLH} , t _{PHL}	125	250	375		T _A = 0°C, +25°C
		155	280	405		T _A = +85°C
Duty Cycle Skew (Note 1)	t _{skew}	—	5	—	ps	T _A = -40°C
Duty Cycle Skew (Note T)		—	5	20		$T_A = 0^{\circ}C$ to +85°C
Input Swing (Note 2)	V _{PP}	150	_	1000	mV	—
Output Rise/Fall Time Q (20% to 80%)	t _r /t _f		160	260	ps	—

Note 1: Duty cycle skew is the difference between a t_{PLH} and t_{PHL} propagation delay through a device.

2: Input swing for which AC parameters are guaranteed. The device has a DC gain of ~40 when output has a full swing.

TEMPERATURE SPECIFICATIONS

Parameters	Symbol	Min.	Тур.	Max.	Units	Conditions	
Temperature Ranges							
Operating Temperature Range	T _A	-40	_	+85	°C	_	
Storage Temperature Range	Τ _S	-65		+150	°C	—	
Lead Temperature	T _{LEAD}	_		+260	°C	Soldering, 20 sec.	
Package Thermal Resistance (MSOP)							
Junction-to-Ambient	θ _{JA}	—	206	—	°C/W	Still Air	
		_	155	_		500 lfpm	
Junction-to-Case	θ _{JC}		39	—	°C/W	—	

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2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 2-1.

TABLE 2-1: PIN FUNCTION TABLE

Pin Number	Pin Name	Description		
1	VCTRL	Output Swing Control.		
2, 3	D, /D	Data Input.		
4	VBB	Reference Voltage Output.		
5	VEE	Negative Power Supply.		
6, 7	Q, /Q	Data Output.		
8	VCC	Positive Power Supply.		

3.0 NOMINAL PERFORMANCE CHARACTERISTICS

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

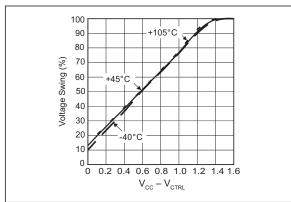
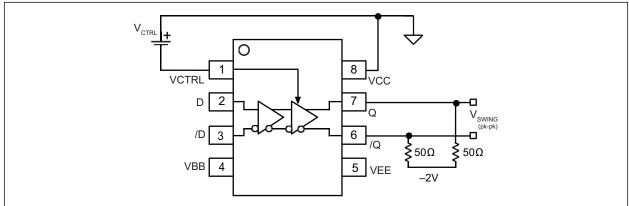
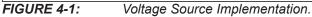


FIGURE 3-1: Typical Voltage Output Swing ($V_{CC} = 3.3V$ or 5V).

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4.0 APPLICATION IMPLEMENTATION





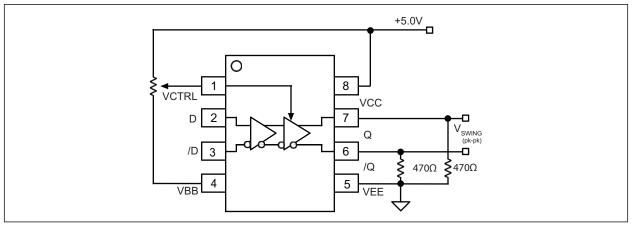
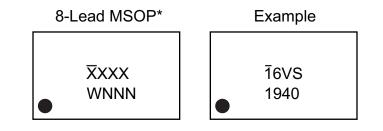


FIGURE 4-2: Alternative Implementation.

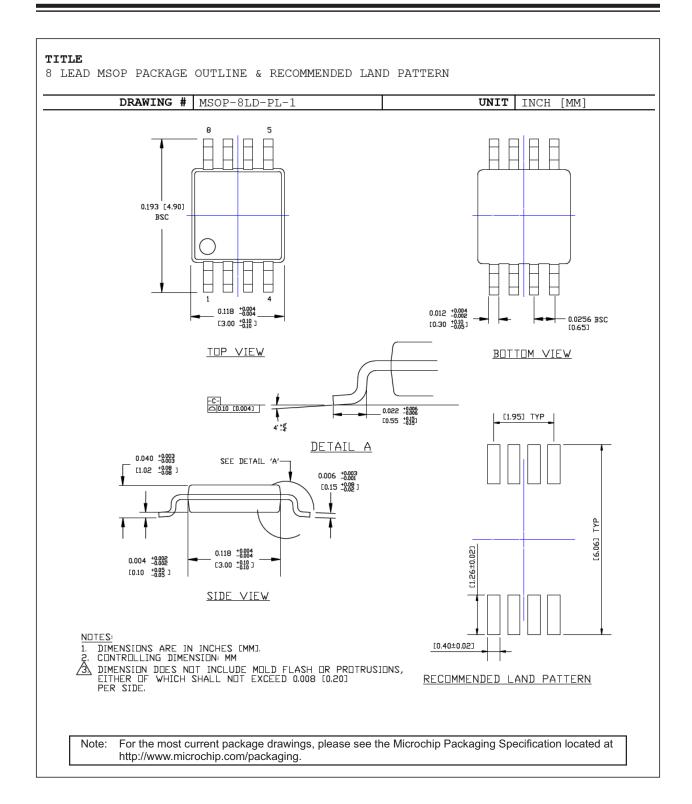
5.0 PACKAGING INFORMATION

5.1 Package Marking Information



Y YY WW NNN (e3) *	Product code or customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC [®] designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package. Pin one index is identified by a dot, delta up, or delta down (triangle
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	Y YY WW NNN @3 * •, ▲, ▼ mark). n the even be carried characters he corpor

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APPENDIX A: REVISION HISTORY

Revision A (August 2019)

- Converted Micrel document SY100EL16VS to Microchip data sheet template DS20006240A.
- Made minor text changes throughout the document.

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NOTES:

PRODUCT IDENTIFICATION SYSTEM

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	~	v	Y	<u>-XX</u>	Exa	imples:	
PART NOXX Device Supply Volta Range	age Special Feature	☐ Package	Temperature Range	Special Processing	a)	SY100EL16VSKG:	SY100EL16, 3.3V/5V, Variable Output Swing, 8-Lead MSOP, -40°C to +85°C,
Device:	SY100EL16: Di	fferential Re	eceiver		b)	SY100EL16VSKG-TR	100/Tube : SY100EL16, 3.3V/5V, Variable Output Swing,
Supply Voltage Range:	V = 3.3V/5V						8-Lead MSOP, -40°C to +85°C, 1.000/Reel
Special Feature:	S = Variable Out	tput Swing					1,000/1001
Package:	K = 8-Lead MSC	OP (Pb-Fre	e NiPdAu)		Note	catalog part numb	entifier only appears in the er description. This identifier is purposes and is not printed on
Temperature Range:	G = -40°C to +8	5°C					e. Check with your Microchip ackage availability with the tion
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